

INTERNATIONAL STANDARD

NORME INTERNATIONALE

**Materials for printed boards and other interconnecting structures –
Part 2-27: Reinforced base materials clad and unclad – Bismaleimide/triazine
modified with non-halogenated epoxide woven glass laminate sheets of defined
flammability (vertical burning test), copper-clad**

**Matériaux pour circuits imprimés et autres structures d'interconnexion –
Partie 2-27: Matériaux de base renforcés, plaqués et non plaqués – Feuilles
stratifiées en tissu de verre de type époxyde non-halogéné modifié, et
bismaléimide-triazine, d'inflammabilité définie (essai de combustion verticale),
plaquées cuivre**



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IEC Central Office
3, rue de Varembe
CH-1211 Geneva 20
Switzerland

Tel.: +41 22 919 02 11
Fax: +41 22 919 03 00
info@iec.ch
www.iec.ch

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

**MATERIALS FOR PRINTED BOARDS AND OTHER
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laminate sheets of defined flammability (vertical burning test), copper-clad**

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International Standard IEC 61249-2-27 has been prepared by IEC technical committee 91: Electronics assembly technology.

The text of this standard is based on the following documents:

FDIS	Report on voting
91/1050/FDIS	91/1063/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 61249 series, published under the general title *Materials for printed boards and other interconnecting structures*, can be found on the IEC website.

The committee has decided that the contents of this publication will remain unchanged until the stability date indicated on the IEC web site under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

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MATERIALS FOR PRINTED BOARDS AND OTHER INTERCONNECTING STRUCTURES –

Part 2-27 Reinforced base materials clad and unclad – Bismaleimide/triazine modified with non-halogenated epoxide woven glass laminate sheets of defined flammability (vertical burning test), copper-clad

1 Scope

This part of IEC 61249 gives requirements for properties of bismaleimide/triazine modified with non-halogenated epoxide woven E-glass reinforced laminated sheets of defined flammability (vertical burning test), copper-clad in thicknesses of 0,03 mm up to 1,60 mm. The flammability rating is achieved through the use of non-halogenated inorganic and/or organic compounds acting as fire retardants. These fire retardants are contained as part of polymeric structure or in addition to it. The glass transition temperature is defined to be 160 °C minimum.

Some property requirements may have several classes of performance. The class desired should be specified on the purchase order, otherwise the default class of material may be supplied.

2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 61189-2:2006, *Test methods for electrical materials, printed boards and other interconnection structures and assemblies – Part 2: Test methods for materials and other interconnection structures*

IEC 61249-5-1:1995, *Materials for interconnection structures – Part 5: Sectional specification set for conductive foils and films with or without coatings – Section 1: Copper foils (for the manufacture of copper-clad base materials)*

IEC/PAS 61249-6-3:2011, *Specification for finished fabric woven from E-glass for printed boards*

ISO 11014:2009, *Safety data sheet for chemical products – Content and order of sections*

3 Materials and construction

3.1 General

The sheet consists of an insulating base with metal-foil bonded to one side or both.

3.2 Resin system

Bismaleimide/triazine modified with non-halogenated epoxide resulting in a laminate with a glass transition temperature of 160 °C minimum. The maximum total halogens contained in the resin plus reinforcement matrix is 1 500 ppm with a maximum chlorine of 900 ppm and maximum bromine being 900 ppm.